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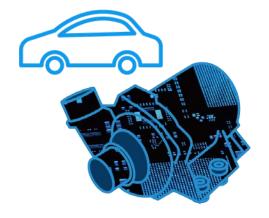
# Automotive Electric Water Pump

**Solution Proposal by Toshiba** 



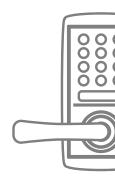










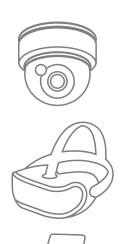








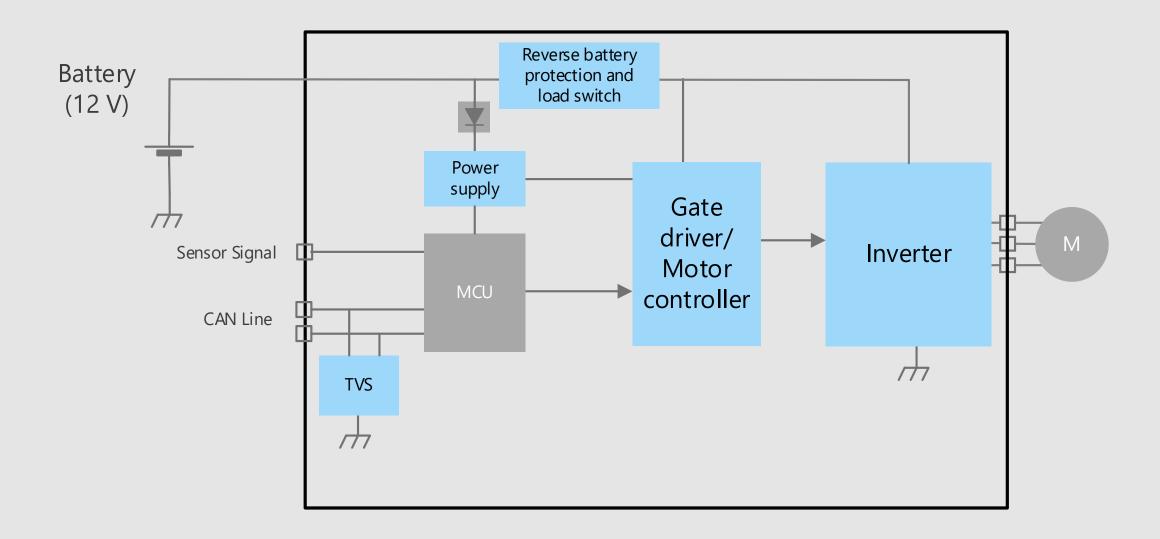
Toshiba Electronic Devices & Storage Corporation provides comprehensive device solutions to customers developing new products by applying its thorough understanding of the systems acquired through the analysis of basic product designs.



# Block Diagram

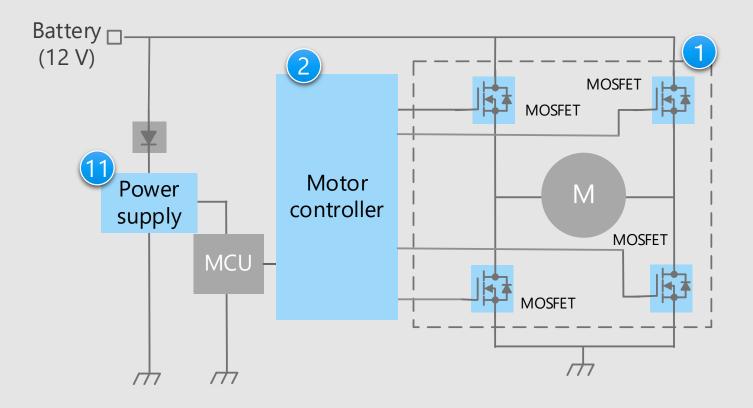
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### Electric Water Pump Overall block diagram



#### Detail of driving circuit fo brushed DC motor Electric Water Pump

### **Driving circuit for brushed DC motor** (N-ch type)



\* Click on the numbers in the circuit diagram to jump to the detailed descriptions page

#### Criteria for device selection

- It is necessary to select the product with the suitable voltage and current ratings for each application.
- It is necessary to select a gate driver according to the characteristics of the switching device to be driven.
- A small surface mount package is suitable for realizing miniaturization of the ECU.

### Proposals from Toshiba

- Low on-resistance contributes low power consumption of the system U-MOS Series 40 V N-ch MOSFET
- H-bridge pre driver compliant with automotive functional safety standard Brushed DC motor pre driver
- Voltage regulator with low current consumption

Power supply IC (for MCU)

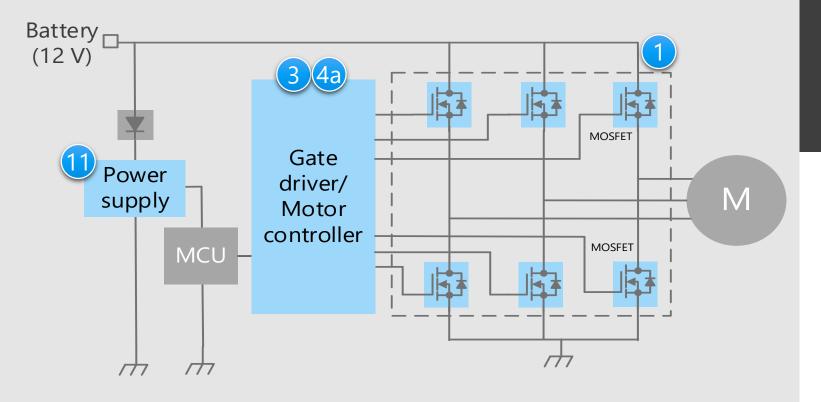






### Electric Water Pump Detail of driving circuit for brushless DC motor (1)

# Driving circuit for brushless DC motor (N-ch type)



\* Click on the numbers in the circuit diagram to jump to the detailed descriptions page

### Criteria for device selection

- It is necessary to select the product with the suitable voltage and current ratings for each application.
- It is necessary to select a gate driver according to the characteristics of the switching device to be driven.
- A small surface mount package is suitable for realizing miniaturization of the ECU.

### Proposals from Toshiba

- Low on-resistance contributes low power consumption of the system
   U-MOS Series 40 V N-ch MOSFET
- Gate driver with protection diagnostic function

Gate driver (for motor)

- Full bridge pre driver compliant with automotive functional safety standard Brushless DC motor pre driver
- Voltage regulator with low current consumption
   Power supply IC (for MCU)



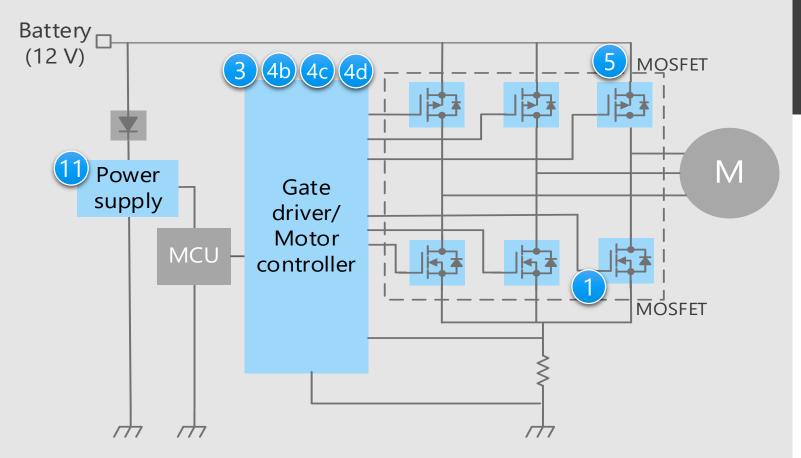






#### Detail of driving circuit for brushless DC motor (2) Electric Water Pump

### **Driving circuit for brushless DC motor** (N-ch/P-ch type)



\* Click on the numbers in the circuit diagram to jump to the detailed descriptions page

### Criteria for device selection

- It is necessary to select the product with the suitable voltage and current ratings for each application.
- It is necessary to select a gate driver according to the characteristics of the switching device to be driven.
- A small surface mount package is suitable for realizing miniaturization of the ECU.

### **Proposals from Toshiba**

- Low on-resistance contributes low power consumption of the system U-MOS Series 40 V N-ch MOSFET
  - U-MOS Series -40 V / -60 V P-ch MOSFET
- **Gate driver with protection diagnostic** function
  - Gate driver (for motor)
- **Full bridge pre driver compliant with** automotive functional safety standard Brushless DC motor pre driver
- Voltage regulator with low current consumption
  - Power supply IC (for MCU)





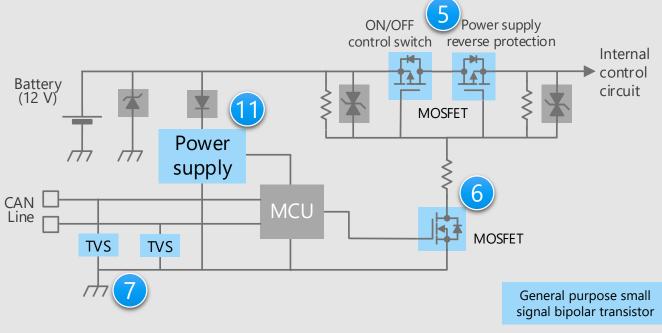








### Power supply ON/OFF control and reverse connection protecting circuit (P-ch type)





Small signal bias resistor built-in transistor (BRT)



\* Click on the numbers in the circuit diagram to jump to the detailed descriptions page

### Criteria for device selection

- It is necessary to select the product with the suitable voltage and current ratings for each application.
- It is necessary to select a gate driver according to the characteristics of the switching device to be driven.
- A small surface mount package is suitable for realizing miniaturization of the ECU.

### Proposals from Toshiba

- Low on-resistance contributes low power consumption of the system

U-MOS Series -40 V / -60 V P-ch MOSFET

**Extensive product lineup** General purpose small signal MOSFET

General purpose small signal bipolar transistor

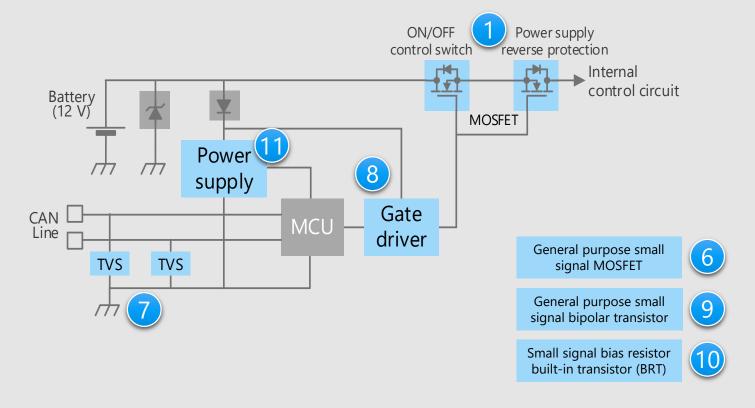
Small signal bias resistor built-in transistor (BRT)

**Suitable for ESD protection** TVS diode (for CAN communication)

- Voltage regulator with low current consumption Power supply IC (for MCU)

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# Power supply ON/OFF control and reverse connection protection circuit (N-ch type)



\* Click on the numbers in the circuit diagram to jump to the detailed descriptions page

### Criteria for device selection

- It is necessary to select the product with the suitable voltage and current ratings for each application.
- It is necessary to select a gate driver according to the characteristics of the switching device to be driven.
- A small surface mount package is suitable for realizing miniaturization of the ECU.

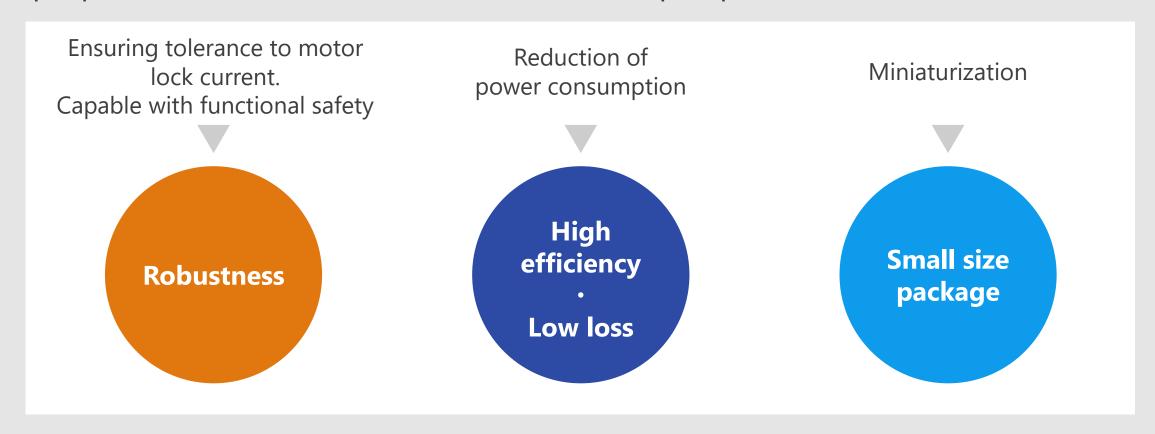
### Proposals from Toshiba

- Low on-resistance contributes low power consumption of the system U-MOS Series 40 V N-ch MOSFET
- Gate driver with protection diagnostic function
   Gate driver (for switch)
- General purpose small signal MOSFET
  General purpose small signal bipolar transistor
  Small signal bias resistor built-in transistor (BRT)
- Suitable for ESD protection
   TVS diode (for CAN communication)
- Voltage regulator with low current consumption
   Power supply IC (for MCU)



### Device solutions to address customer needs

As described above, in the design of Electric Water Pump, "Ensuring tolerance to motor lock current. Capable with functional safety", "Reduction of power consumption" and "Miniaturization" are important factors. Toshiba's proposals are based on these three solution perspectives.



### Device solutions to address customer needs

		Robustness	High efficiency - Low loss	Small size package
1	U-MOS Series 40 V N-ch MOSFET			
2	Brushed DC motor pre driver			
3	Gate driver (for motor)			
4	Brushless DC motor pre driver			
5	U-MOS Series -40 V / -60 V P-ch MOSFET			
6	General purpose small signal MOSFET			
7	TVS diode (for CAN communication)			
8	Gate driver (for switch)			
9	General purpose small signal bipolar transistor			
10	Small signal bias resistor built-in transistor (BR	T)		
11	Power supply IC (for MCU)			

### **U-MOS Series 40 V N-ch MOSFET**

XPN3R804NC / TK1R4S04PB / TPHR7904PB / TPWR7904PB / TKR74F04PB / TK1R5R04PB







Value provided

The advanced U-MOSIX-H processes enables low on-resistance and low noise, thereby reducing power consumption.

### Low loss (reduced on-resistance)

Using low on-resistance technology to contribute to reduced power consumption systems.

On-resistance of 61 % reduction per unit area. (compared to U-MOSIV)

# 2 Compact and low loss package

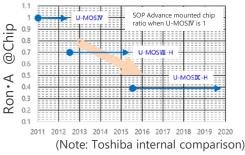
By adopting a Cu connector structure and a double-sided heat dissipation structure, low loss and high heat dissipation are realized.

Wettable Frank (WF) package contributes good mountability.

### 3 Low noise (low EMI)

Improved chip process reduces surge voltage and ringing time.

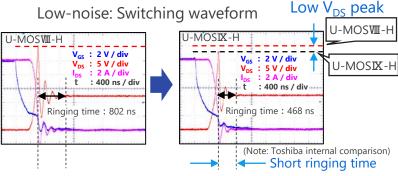
#### Low Loss: RonA Trend



TO-220SM(W) Cu connector design

F

Package resistance is reduced by 64 %, compared to D2PAK+.



DSOP Advance(WF)L double-sided cooling package



Thermal resistance is reduced by 76 % @t = 3 s, mounted on board compared to SOP Advance(WF).

Ш	Line up						
_ -	Part number	Drain current	On-resistance (Max) @V <sub>GS</sub> = 10 V	Package			
_	XPN3R804NC	40 A	3.8 mΩ	TSON Advance(WF)			
	TK1R4S04PB	120 A	1.35 mΩ	DPAK+			
	TPHR7904PB	150 A	0.79 mΩ	SOP Advance(WF)			
	TPWR7904PB	150 A	0.79 mΩ	DSOP Advance(WF)L			
_	TKR74F04PB	250 A	0.74 mΩ	TO-220SM(W)			
_	TK1R5R04PB	160 A	1.5 mΩ	D2PAK+			







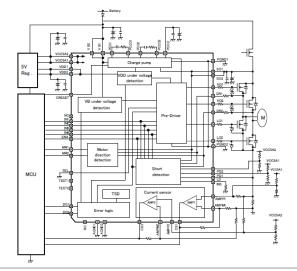
### Compliant with automotive functional safety standard (ISO26262 : ASIL-D) and motor current detecting function is built in.

Compliant with automotive functional safety standard

Compliant with ISO26262 ASIL-D. [Note1] FMEDA [NOTE2] and safety manuals can be provided.

[Note1] Automotive Safety Integrity Level [Note2] Failure Modes Effects and Diagnostics Analysis

TB9057FG Typical Connection Diagram



Built-in motor current detection amplifier

Two channels of motor current detection amplifiers are built in to make them redundant.

**3** AEC-Q100 qualified

It is AEC-Q100 qualified and it can be used for various automotive applications.

Line up					
	Part number	TB9057FG			
	Package	LQFP48			
	Package body size	7.0 x 7.0 mm			
	Control method	Direct			
	External MOSFET (High side / Low side)	N-ch / N-ch			
Function	Detection of overheating, low voltage and short circuit	✓			
	Output of detection function diagnosis result	✓			







### The high gate drive current capability reduces MOSFET losses and improves the efficiency of system.

### **High gate drive current**

High drive current capability and high speed switching contribute to reduce the loss.

TPD7211F: ±0.5 A

TPD7212F, TPD7212FN: -1 / +1.5 A

**Built-in protection /** diagnostic output function

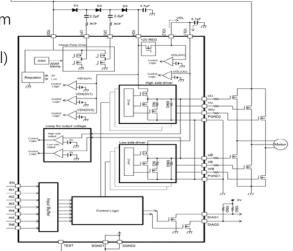
MOSFET is turn off when a signal is input that causes arm short circuit.

Functions to monitor abnormalities of the power supply voltage and output voltage are built-in.

**Small surface mount** package

PS-8, WQFN32 and SSOP30 are small surface mount packages. It contributes to the miniaturization of system.

Example of application and block diagram of TPD7212F, TPD7212FN (Three phase brushless DC motor control)



Line up		
Part number	TPD7211F	TPD7212F / TPD7212FN
Function	Half bridge output gate driver	Gate driver for three-phase brushless motor
Number of output	put 2 outputs 6 outputs	
Package	PS-8 (2.8 x 2.9 mm)	TPD7212F TPD7212FN Back surface WQFN32 (5 x 5 mm) SSOP30 (7.6 x 10.2 mm)
Features	·For high-side P-ch MOSFET drive	<ul> <li>For driving high-side N-ch MOSFET         (with built-in charge pumps)</li> <li>Built-in voltage monitoring function         (power supply, output)</li> </ul>







Compliant with automotive functional safety standard (ISO 26262 : ASIL-D) and safety relay drivers are built in.

Compliant with automotive functional safety standard

Compliant with ISO 26262 ASIL-D. [NOTE 1] FMEDA [NOTE 2] and safety manuals can be provided.

[NOTE 1] Automotive Safety Integrity Level [NOTE 2] Failure Modes Effects and Diagnostics Analysis **Built-in safety relay drivers** and motor current detection amplifiers

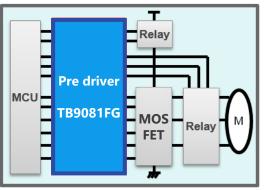
The safety relay drivers are built in for the power supply side MOSFETs and the motor phase cut MOSFETs. In addition, a 3 channels of motor current detection amplifiers are built in to support 3 shunts.

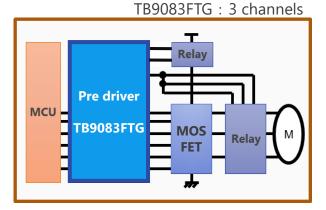
3 AEC-Q100 qualified

It is AEC-Q100 qualified and it can be used for various automotive applications.

Built-in safety relay drivers

TB9081FG: 5 channels





Line up

	Part number	TB9081FG	TB9083FTG*
Package		LQFP64	WQFN48
Pa	ickage body size	10.0 x 10.0 mm	7.0 x 7.0 mm
Operatin	g ambient temperature	Ta = -40 to 125 °C	Ta = -40 to 150 °C
	Control method	Direct	Direct
	External MOSFET (High side / Low side)	N-ch / N-ch	N-ch / N-ch
Function	Detection of overheating, low voltage and short circuit	<b>√</b>	<b>√</b>
	Output of detection function diagnosis result	✓ (BIST [Note 3])	✓ (BIST)

[Note 3] Built-in Self Test

<sup>\*</sup> TB9083FTG: Under development (The specification is subject to change without notice.)







It is built in a sensorless control circuit and can drive a brushless DC motor without using Hall elements.

Three-phase sensorless drive

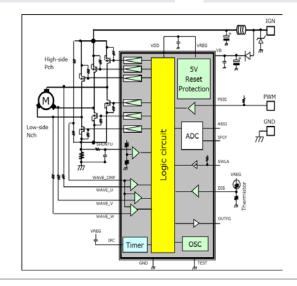
It can drive a brushless DC motor by change of detecting the back electromotive force of each motor phase without using Hall elements. 2 Built-in external MOSFET drive circuits

It is built in 6 drivers for external P-ch and N-ch MOSFETs.

3 AEC-Q100 qualified

AEC-Q101 qualified and can be used for various automotive applications.

Application circuit example



Line up					
Part number	TB9061AFNG				
Package	SSOP24 (7.8 x 7.6 mm)				
Power supply voltage VB (Max) [V]	40				
Output voltage VOH / VOL [V]	VB-0.5@ IOH = -20 mA / 0.5 @ IOL = 20 mA				
PWM frequency fpint (Typ.) [kHz]	24				
Oscillation frequency fosc (Typ.) [MHz]	6.14				







#### Sensorless control circuit is built in and can be used without Hall devices.

# 3-phase sensorless drive system

Brushless DC motor can be driven without Hall devices by detecting changes in the induced voltage of each phase of the motor.

# 3-phase 6 outputs for external MOSFETs driving

It has 3-phase 6 outputs for P-channel / N-channel external MOSFETs driving.

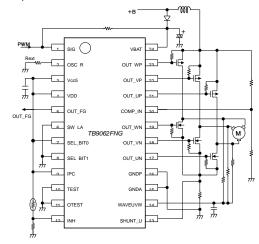
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Oscillation frequency f<sub>osc</sub> [MHz] (Typ.)

# Stable start-up and step-out prevention function

Stable start-up is realized because the start duty is automatically selected according to the battery voltage fluctuation. It also has a function to suppress the sudden change in output duty in response to a sudden change in input duty to prevent step-out.

#### Application circuit example



Line up					
Part number	TB9062FNG				
Package	SSOP24-P-300-0.65A (7.8 x 7.6 mm)				
Power supply voltage V <sub>B</sub> [V] (Max)	40				
Output voltage V <sub>OH</sub> / V <sub>OL</sub> [V] (Max)	V <sub>B</sub> -0.5 / 0.5 @ I <sub>OUT</sub> =1 mA				
PWM frequency f <sub>pint</sub> [kHz] (Typ.)	17.0 @ Rext=39 kΩ				

◆ Return to Block Diagram TOP

4.00 @ Rext=39 kΩ







#### It is suitable for sensor type brushless DC motor control.

# Compatible with both internal PWM drive and external direct drive

The PWM signals can be input are as follows.

#### PWM frequency

Internal PWM drive : 4 kHz (Max)

External direct drive: 23 kHz (Max)

# 2 3-phase 6 outputs for external MOSFETs driving

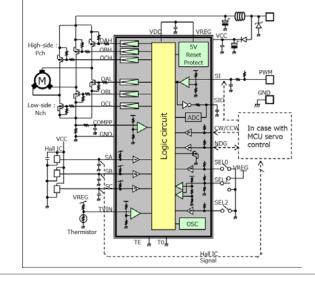
It has 3-phase 6 outputs for P-channel / N-channel external MOSFETs driving.

### Built-in various abnormality detection functions

This IC has a variety of built-in abnormality detection functions.

- External motor driver overcurrent / overheat detection
- BIAS voltage rise / fall detection
- 100 % drive detection

Application circuit example



Line up					
Part number	TB9067FNG				
Package	SSOP24-P-300-0.65A (7.8 x 7.6 mm)				
Power supply voltage V <sub>B</sub> [V] (Max)	40				
Output voltage V <sub>OH</sub> (Min) / V <sub>OL</sub> (Max) [V]	BIAS-0.3 / 0.3 @ I <sub>OUT</sub> =∓10 mA				
PWM frequency f <sub>pint</sub> [kHz] (Typ.)	20				
Oscillation frequency f <sub>osc</sub> [MHz] (Typ.)	5.12				

# 5

# U-MOS Series -40 V / -60 V P-ch MOSFET TJ90S04M3L / TJ60S06M3L / XPH3R114MC / TJ200F04M3L







Value provided

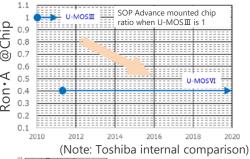
#### Low on-resistance contributes to reduce system power consumption.

# Low loss (reduced on-resistance) and logic level drive

Using low on-resistance technology contributes to reduce system power consumption.

Lineups of logic level drive type are supported.

#### Low Loss: RonA Reduction Trend



Logic level drive TJ90S04M3L V<sub>DS(ON)</sub> - V<sub>GS</sub> Large current, small size, high heat
dissipation package
TO-220SM(W)
(10 x 13 mm)
DPAK+
Up to 200 A
(6.5 x 9.5 mm)
SOP

Up to 90 A Advance(WF) (5 x 6 mm)

Up to 100 Å

Plating Wettable Flank (WF) structure

### **Small surface mount package developed**

By adopting a Cu connector structure and a double-sided heat dissipation structure, low loss and high heat dissipation are realized.

Wettable Frank (WF) package contributes good mountability.

#### Line up

Part number	Drain-source Voltage	Drain current	On-resistance (Max) @V <sub>GS</sub> = -10 V	Package
TJ90S04M3L	-40 V	-90 A	4.3 mΩ	DPAK+
TJ60S06M3L	-60 V	-60 A	11.2 mΩ	DPAK+
XPH3R114MC	-40 V	-100 A	3.1 mΩ	SOP Advance(WF)
TJ200F04M3L	-40 V	-200 A	1.8 mΩ	TO-220SM(W)



# General purpose small signal MOSFET SSM3K7002KF / SSM3J168F / SSM3J66MFV







Value provided

#### Wide lineup of small packages contribute to reduce the size and power consumption of system.

### Small package

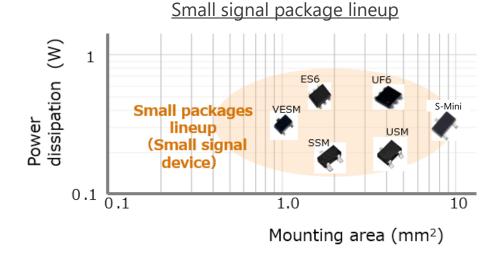
A lineup of various small packages such as SOT-723 (VESM 1.2 x 1.2 mm package) is available, contributing to reduce mounting area.

### **Description**Low voltage drive

SSM3J66MFV can be driven at low gatesource voltage of 1.2 V.

### 3 AEC-Q101 qualified

AEC-Q101 qualified and can be used for various automotive applications.



Line up					
Part number		SSM3K7002KF	SSM3J168F	SSM3J66MFV	
Package		S-Mini (SOT-346)	S-Mini (SOT-346)	VESM (SOT-723)	
V <sub>DSS</sub> [V]		60	-60	-20	
I <sub>D</sub> [A]	I <sub>D</sub> [A]		-0.4	-0.8	
R <sub>DS(ON)</sub>	Тур.	1.2	1.4	0.31	
@ $ V_{GS}  = 4.5 V [Ω]$ Max		1.75	1.9	0.39	
Drive voltage [V]		4.5	-4.0	-1.2	
Polarity		N-ch	P-ch	P-ch	







#### TVS diodes prevent system damage and malfunction caused by electrostatic discharge (ESD).

# Improve ESD pulse absorbability

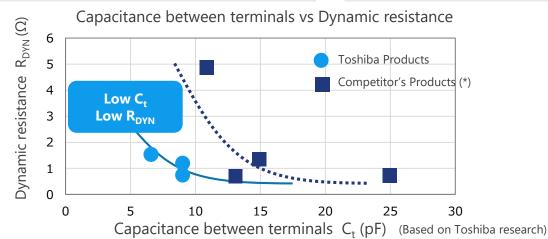
Toshiba proprietary Zener process improves the ESD pulse absorption of TVS diodes. (Both low dynamic resistance  $R_{\text{DYN}}$  and low capacitance between terminals  $C_{\text{t}}$ )

# Supports CAN, CAN FD and FlexRay

These are products applicable to invehicle LAN communication such as CAN, CAN FD and FlexRay.

### **3** High ESD immunity

 $V_{ESD} > \pm 30 \text{ kV} @ ISO 10605$  $V_{ESD} > \pm 20 \text{ kV} (L4) @ IEC61000-4-2$ 



Line up					
Part number	DF3D18FU	DF3D36FU			
Package	USM (SOT-323)				
V <sub>ESD</sub> [kV] @ISO 10605	±30	±30	±20		
V <sub>RWM</sub> (Max) [V]	12	24	28		
C <sub>t</sub> (Typ. / Max) [pF]	9 / 10 6.5 / 8		6.5 / 8		
$R_{DYN}$ (Typ.) [ $\Omega$ ]	0.8	1.1	1.5		

(NOTE): This product is an ESD protection diode and cannot be used for purposes other than ESD protection.

(\*): Measurements of the commercial product







A charge pump circuit for the N-ch MOSFET gate drive is built in, allowing for easy semiconductor relay configuration.

Built-in charge pump circuit

Built-in charge pump circuit enables N-ch MOSFET as high side switch.

Easy to configure a semiconductor relay.

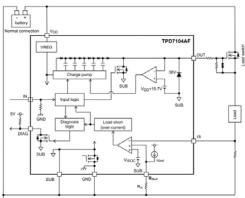
Can be controlled by logic level voltage

It is possible that Direct control by output signal of MCUs or CMOS logic ICs.

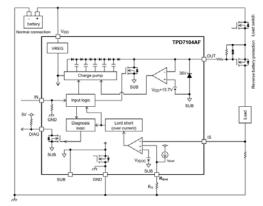
**3** Small package

The small surface mount packages such as PS-8, SSOP16 and WSON10A contribute to the miniaturization of equipment.

Semiconductor relay (switch) application (TPD7104AF)



Power supply reverse connection protection MOSFET control (TPD7104AF)



Back to back configuration

Line up						
Part number	TPD7104AF	TPD7106F	TPD7107F			
Package	PS-8 (2.8 x 2.9 mm)	SSOP16 (5.5 x 6.4 mm)	WSON10A (3 x 3 mm)			
Features	Operating power supply voltage range: 5 to 18 V     Built-in power supply reverse connection protection function (Supported for power supply reverse connection protection MOSFET applications)	Operating power supply voltage range: 4.5 to 27 V     Built-in power supply reverse connection protection function (Supported for power supply reverse connection protection MOSFET applications)	Operating power supply voltage range: 5.75 to 26 V     Current sense output     Protective functions; overcurrent, overtemperature, GND disconnect etc. reverse battery connection     Diagnosis output; overcurrent, load open, overtemperature etc.			



# General purpose small signal bipolar transistor 2SC2712 / 2SA1162 / 2SC4116 / 2SA1586 / TTA501 / TTC501 and others







Value provided

#### **Extensive product lineup to meet customers' needs.**

### **Extensive lineup of packages**

Various packages such as 1-in-1, 2-in-1 are provided and suitable products for circuit board design are selectable.

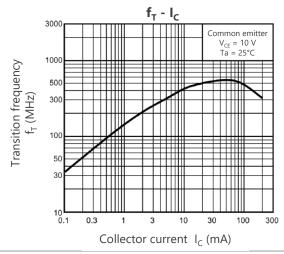
### **Extensive product lineup**

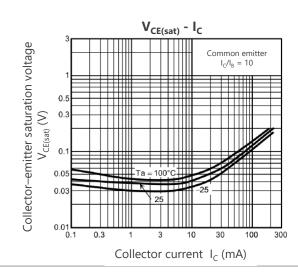
Various product lineups, such as general purpose, low noise, low  $V_{\text{CE(sat)}}$  and high current types are provided. Products can be selected in accordance to the application.

### **3** AEC-Q101 qualified

AEC-Q101 qualified and can be used for various automotive applications.

#### **Characteristic examples of 2SC2712**





Line up								
Package			SOT-23F		USM (SOT-323) UFM (SOT-323F)*		S-Mini (SOT-346)	
Classification	V <sub>CEO</sub> [V]	I <sub>C</sub>   [mA]	NPN	PNP	NPN	PNP	NPN	PNP
General purpose	50	150			2SC4116	2SA1586	2SC2712	2SA1162
	50	500					2SC3325	2SA1313
Low noise	120	100			2SC4117	2SA1587	2SC2713	2SA1163
High current	50	1700				2SA2195*		
	50	2000		TTA501				
	100	2500	TTC501					

# Small signal bias resistor built-in transistor (BRT) RN1907FE / RN2907FE / RN1901 / RN2901 Series







Value provided

#### **Extensive product lineup to meet customers' needs.**

Built-in bias resistor type
(BRT: Bias Resistor built-in Transistor)

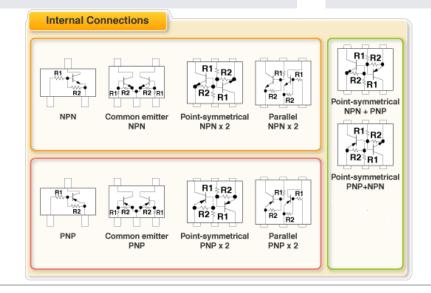
The BRTs contribute to reduction of the number of components, assembly workload and mounting area of circuit boards.

2 Extensive lineup of package and pin assignment

Various package lineups, such as 1-in-1, 2-in-1 and various pin assignment type are provided and suitable products for circuit board design are selectable.

**3** AEC-Q101 qualified

AEC-Q101 qualified and can be used for various automotive applications.



Line up						
Part number		NPN (BRT)	PNP (BRT)			
Package	ES6 (SOT-563)	RN1907FE	RN2907FE			
	US6 (SOT-363)	RN1901	RN2901			
V <sub>CEO</sub> (Max) [V]		50	-50			
	I <sub>C</sub> [mA]	100	-100			







This is voltage regulator with low current consumption, and various monitoring functions such as WDT<sup>[Note]</sup> contribute to improving system stability.

### Low current consumption

External transistor type voltage regulator with low current consumption.

Load stability is +/-1 %.

# **2** Built-in WDT and various monitoring functions

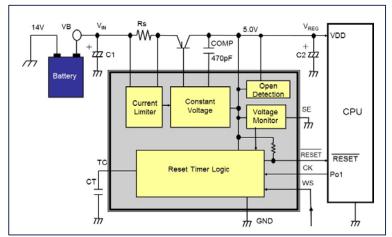
The WDT monitors the operation of the MCU.

In addition, current detection functions contribute to improving system safety.

### **3** AEC-Q100 qualified

It is AEC-Q100 qualified and can be used for various automotive applications.

Application circuit example (The current limiter can be adjusted by an external resistor.)



Line up					
	Part number	TB9005FNG			
	Package	SSOP20 (6.4 x 7.0 mm			
Curren	t consumption I <sub>CC</sub> (Typ.) [μΑ]	90 (@V <sub>IN</sub> = 12 V, Ta = 25 °C)			
Load	stability VLOAD (Max) [%]	1 (@ILOAD = 1 to 300 mA)			
u C	Number of outputs	1 ch (5 V)			
Function	Circuit type	External transistor type			
- Pu	WDT, Overcurrent limitation	✓			

If you are interested in these products and have questions or comments about any of them, please do not hesitate to contact us below:

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